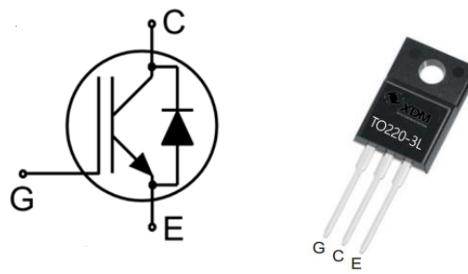


Trench Field-Stop Technology IGBT

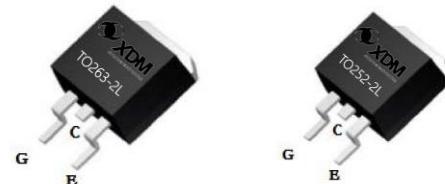
Features

- 600V, 6A
- $V_{CE(sat)(typ.)} = 1.75V @ V_{GE}=15V, I_C=6A$
- Maximum Junction Temperature 175°C
- Pb-free Lead Plating; RoHS Compliant



Applications

- Solar Converters
- Uninterrupted Power Supply
- Welding Converters
- Mid to High Range Switching Frequency Converters



Key Performance and Package Parameters

Order codes	V_{CE}	I_C	$V_{CEsat}, T_{vj}=25^\circ C$	T_{vjmax}	Marking	Package
XD006H060CX1H3	600V	6A	1.75V	175°C	D6H60CX1H3	TO220F-3L
XD006H060CX1R3	600V	6A	1.75V	175°C	D6H60CX1R3	TO263-2L
XD006H060CX1G3	600V	6A	1.75V	175°C	D6H60CX1G3	TO252-2L

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage	600	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Continuous Collector Current ($T_c=25^\circ C$)	12	A
	Continuous Collector Current ($T_c=100^\circ C$)	6	A
I_{CM}	Pulsed Collector Current (Note 1)	18	A
P_D	Maximum Power Dissipation ($T_c=25^\circ C$) (Note 2)	89	W
	Maximum Power Dissipation ($T_c=100^\circ C$) (Note 2)	44	W
T_J	Operating Junction Temperature Range	-40 to 175	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Conditioins	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case for IGBT	TO220F-3L	3.6	°C/W
		TO263-2L	1.6	°C/W
		TO252-2L	1.6	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case for Diode	TO220F-3L	3.7	°C/W
		TO263-2L	2.6	°C/W
		TO252-2L	2.2	°C/W

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted.)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{CES}	Collector-Emitter Breakdown Voltage	$V_{\text{GE}}=0\text{V}, I_{\text{C}}=200\mu\text{A}$	600	---	---	V
I_{CES}	Collector-Emitter Leakage Current	$V_{\text{CE}}=600\text{V}, V_{\text{GE}}=0\text{V}$	---	---	40	μA
I_{GES}	Gate Leakage Current, Forward	$V_{\text{GE}}=20\text{V}, V_{\text{CE}}=0\text{V}$	---	---	100	nA
	Gate Leakage Current, Reverse	$V_{\text{GE}}=-20\text{V}, V_{\text{CE}}=0\text{V}$	---	---	100	nA
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GE}}=V_{\text{CE}}, I_{\text{C}}=200\mu\text{A}$	3.2	3.9	4.8	V
$V_{\text{CE}(\text{sat})}$	Collector-Emitter Saturation Voltage	$V_{\text{GE}}=15\text{V}, I_{\text{C}}=6\text{A}, T_j=25^\circ\text{C}$	---	1.75	2.10	V
		$V_{\text{GE}}=15\text{V}, I_{\text{C}}=6\text{A}, T_j=150^\circ\text{C}$	---	2.05	---	V
Q_{G}	Total Gate Charge	$V_{\text{CC}}=400\text{V}$ $V_{\text{GE}}=15\text{V}$ $I_{\text{C}}=6\text{A}$	---	11.5	---	nC
Q_{GE}	Gate-Emitter Charge		---	3.5	---	nC
Q_{GC}	Gate-Collector Charge		---	3.5	---	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{CC}}=400\text{V}$ $V_{\text{GE}}=\pm 15\text{V}$ $I_{\text{C}}=6\text{A}$ $R_{\text{G}}=10\Omega$ Inductive Load $T_c=25^\circ\text{C}$	---	12	---	ns
t_{r}	Turn-on Rise Time		---	6	---	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		---	14	---	ns
t_{f}	Turn-off Fall Time		---	154	---	ns
E_{on}	Turn-on Switching Loss		---	91	---	μJ
E_{off}	Turn-off Switching Loss		---	95	---	μJ
E_{ts}	Total Switching Loss		---	186	---	μJ
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{CC}}=400\text{V}$ $V_{\text{GE}}=\pm 15\text{V}$ $I_{\text{C}}=6\text{A}$ $R_{\text{G}}=10\Omega$ Inductive Load $T_c=150^\circ\text{C}$	---	3	---	ns
t_{r}	Turn-on Rise Time		---	6	---	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		---	18	---	ns
t_{f}	Turn-off Fall Time		---	214	---	ns
E_{on}	Turn-on Switching Loss		---	48	---	μJ
E_{off}	Turn-off Switching Loss		---	211	---	μJ
E_{ts}	Total Switching Loss		---	259	---	μJ
C_{ies}	Input Capacitance	$V_{\text{CE}}=25\text{V}$ $V_{\text{GE}}=0\text{V}$ $f = 1\text{MHz}$	---	313	---	pF
C_{oes}	Output Capacitance		---	34	---	pF
C_{res}	Reverse Transfer Capacitance		---	5	---	pF
SCSOA	Short Circuit Safe Operation Area	$V_{\text{GE}}=15\text{V}, V_{\text{CC}} \leq 400\text{V}, T_{\text{J, start}} \leq 25^\circ\text{C}$	9	---	---	us

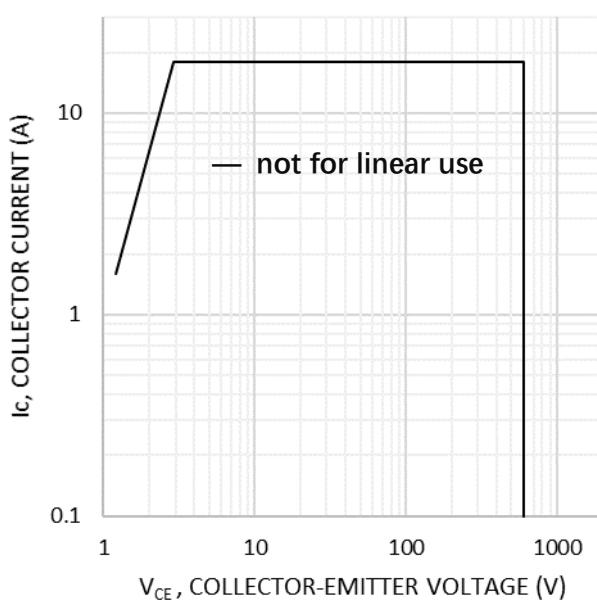
Diode Characteristics ($T_c=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=6A, T_j=25^\circ C$	---	1.65	2.10	V
		$I_F=6A, T_j=150^\circ C$	---	1.48		V
t_{rr}	Diode Reverse Recovery Time	VR=400V $I_F=6A$ $dI_F/dt=20A/\mu s$ $T_c=25^\circ C$	---	46.5	---	ns
I_{rr}	Diode peak Reverse Recovery Current		---	0.35	---	A
Q_{rr}	Diode Reverse Recovery Charge		---	8.5	---	nC
t_{rr}	Diode Reverse Recovery Time	VR=400V $I_F=6A$ $dI_F/dt=20A/\mu s$ $T_c=150^\circ C$	---	230	---	ns
I_{rr}	Diode peak Reverse Recovery Current		---	1	---	A
Q_{rr}	Diode Reverse Recovery Charge		---	115	---	uC

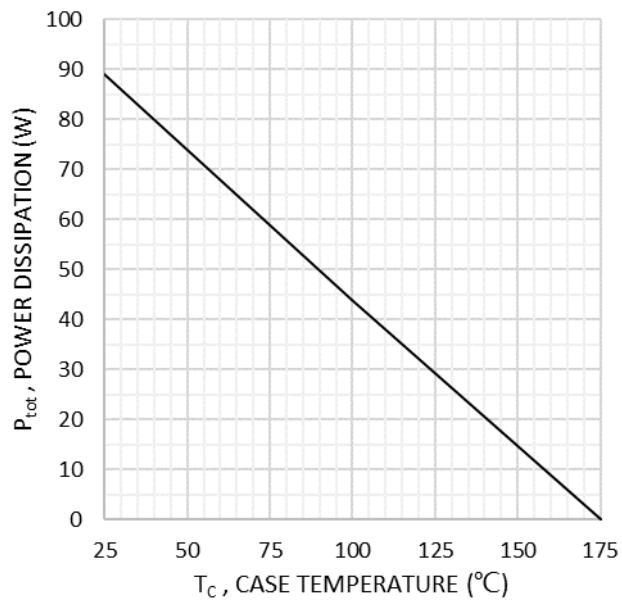
Note1: Repetitive rating, pulse width limited by maximum junction temperature

Note2: For TO-263

Typical Characteristics



**Fig. 1 Forward bias safe operating area (D=0,
 $T_c=25^\circ\text{C}$, $T_{vj}\leq 175^\circ\text{C}$; $V_{GE}=15\text{V}$)**



**Fig. 2 Power dissipation as a function of case
 temperature ($T_{vj}\leq 175^\circ\text{C}$)**

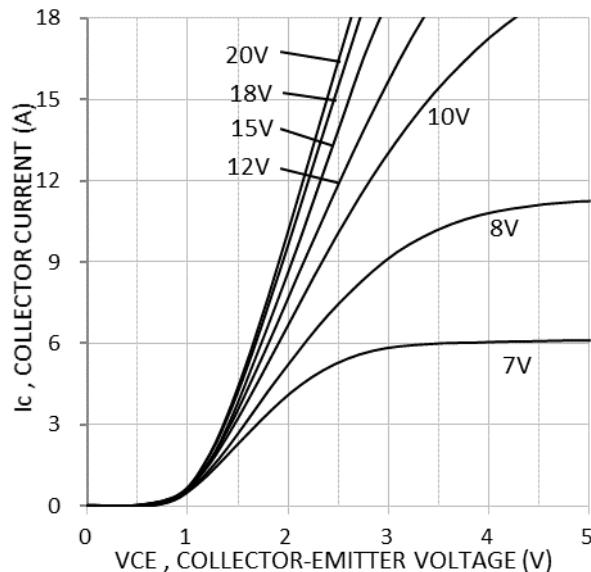


Fig. 3 Typical output characteristic ($T_{vj}=25^\circ\text{C}$)

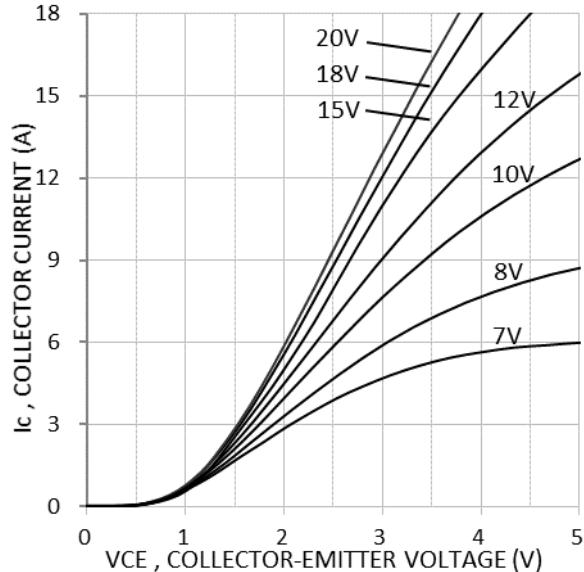


Fig. 4 Typical output characteristic ($T_{vj}=150^\circ\text{C}$)

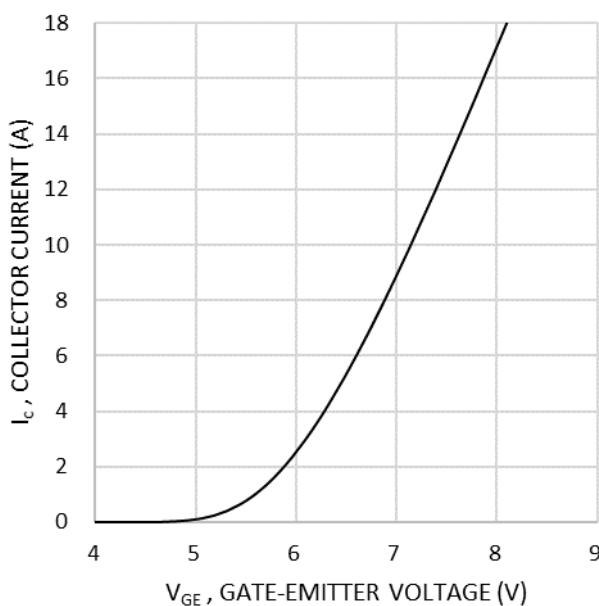


Fig. 5 Typical transfer characteristics ($V_{CE}=10V$)

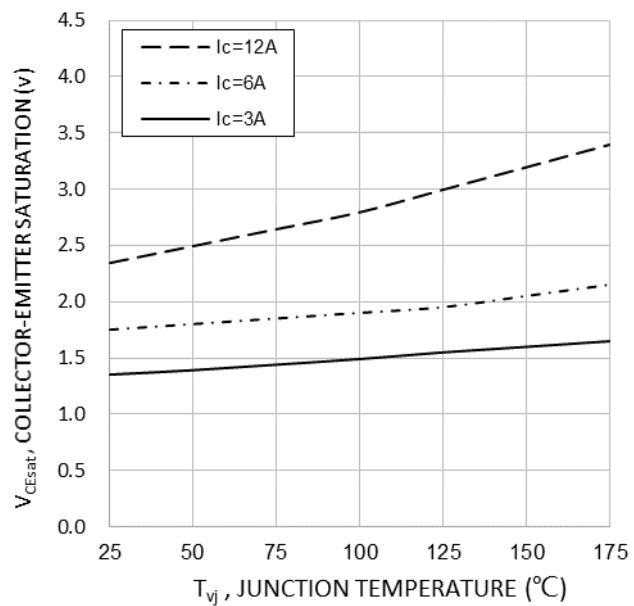


Fig. 6 Typical collector-emitter saturation voltage as a function of junction temperature ($V_{GE}=15V$)

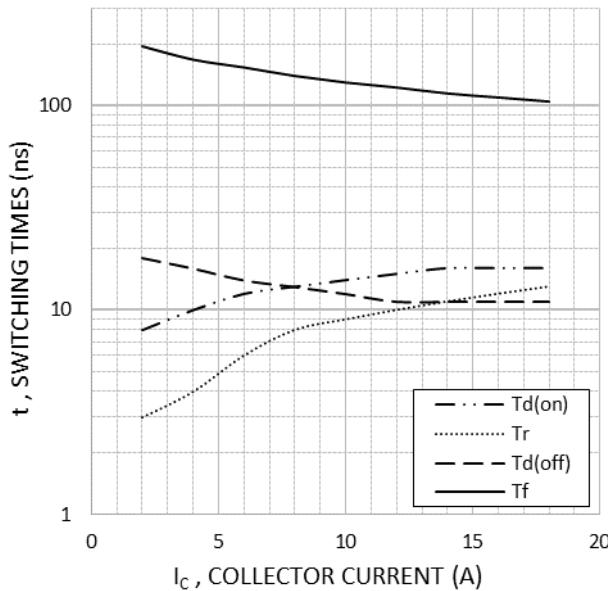


Fig. 7 Typical switching times as a function of collector current (inductive load, $T_{vj}=25^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $r_G=10\Omega$)

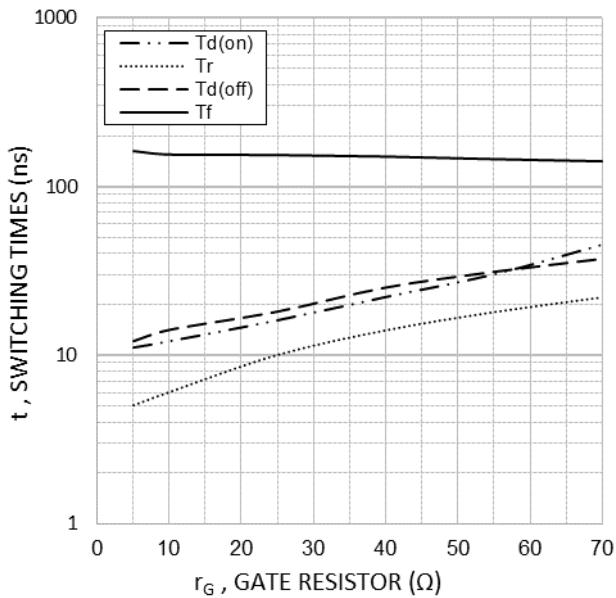


Fig. 8 Typical switching times as a function of gate resistor (inductive load, $T_{vj}=25^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $V_{GE}=15/0\text{V}$, $I_c=6\text{A}$)

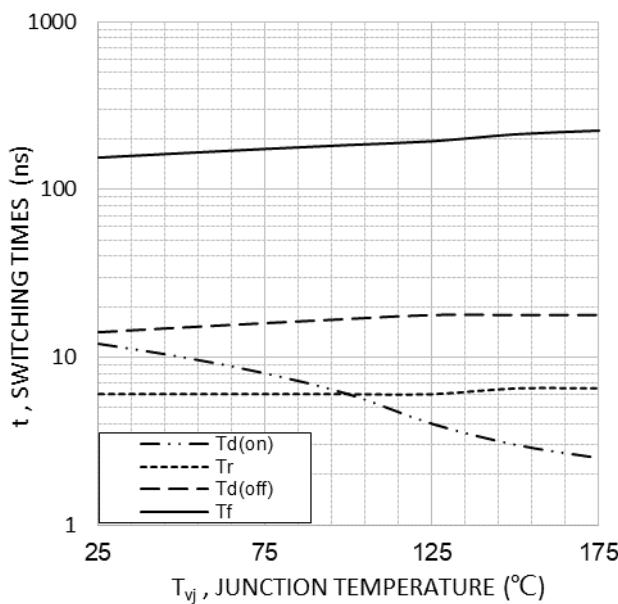


Fig. 9 Typical switching times as a function of junction temperature (inductive load,
 $V_{CE}=400V$, $V_{GE}=15/0V$, $I_C=6A$, $r_G=10\Omega$)

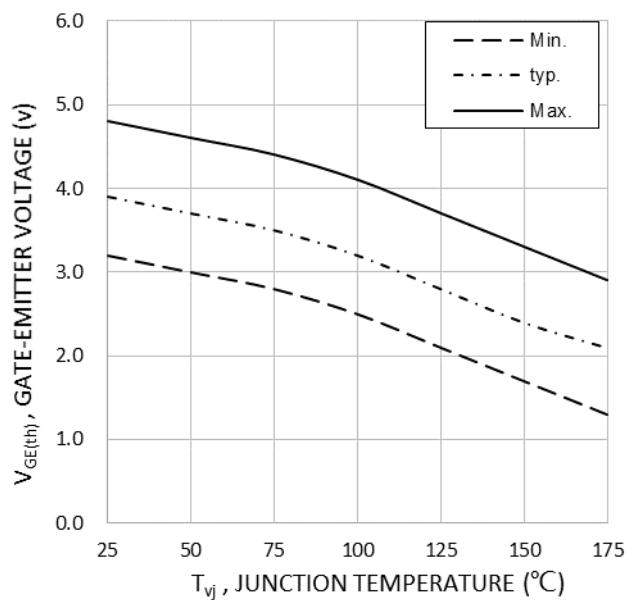


Fig. 10 Gate-emitter threshold voltage as a
 function of junction temperature
 $(I_C=0.2mA)$

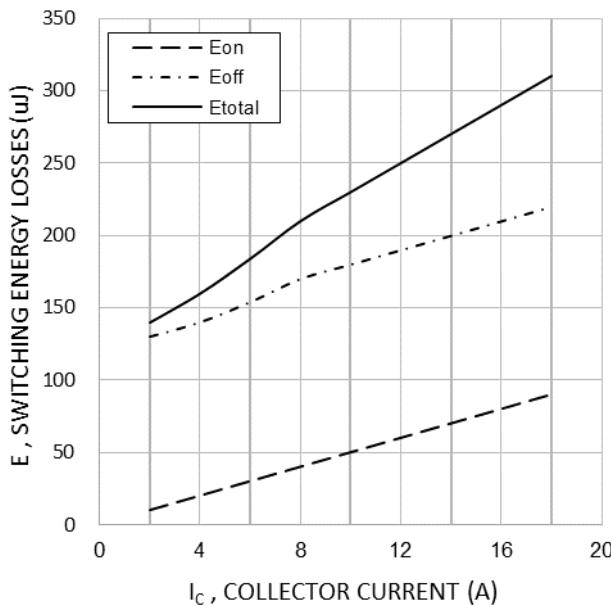


Fig. 11 Typical switching energy losses as a
 function of collector current (inductive load,
 $T_{j}=25^{\circ}C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $r_G=10\Omega$)

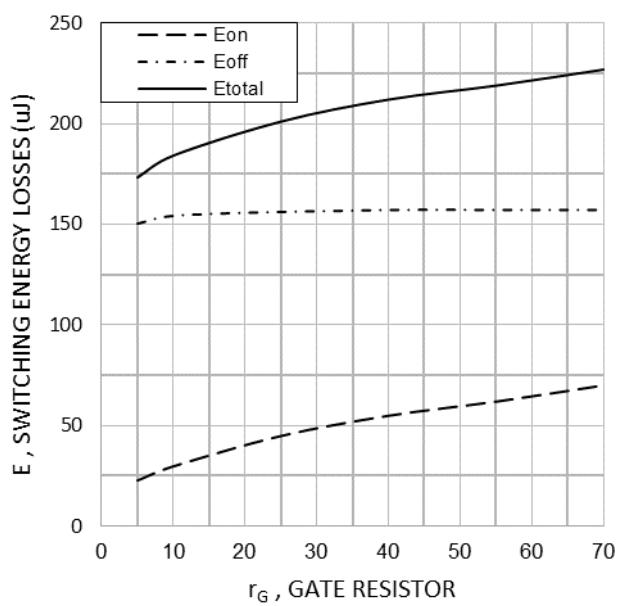


Fig. 12 Typical switching energy losses as a
 function of gate resistor (inductive load,
 $T_{j}=25^{\circ}C$, $V_{CE}=400V$, $V_{GE}=15/0V$, $I_c=6A$)

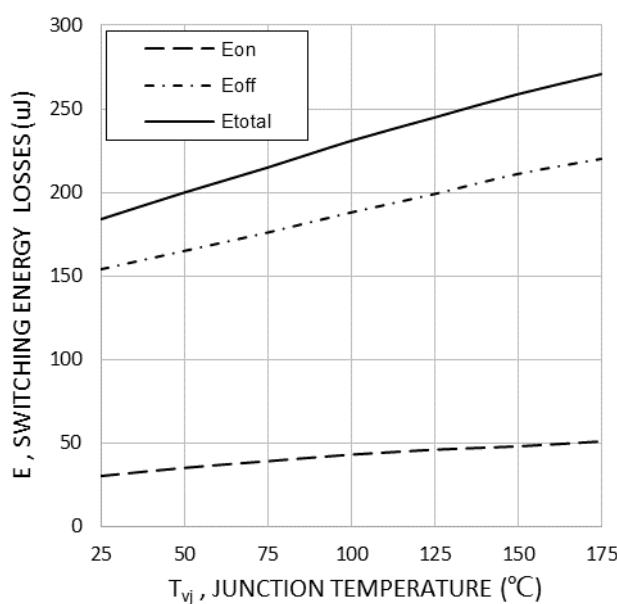


Fig. 13 Typical switching energy losses as a function of junction temperature (inductive load,
 $V_{CE}=600V$, $V_{GE}=15/0V$, $I_C=50A$, $r_G=10\Omega$)

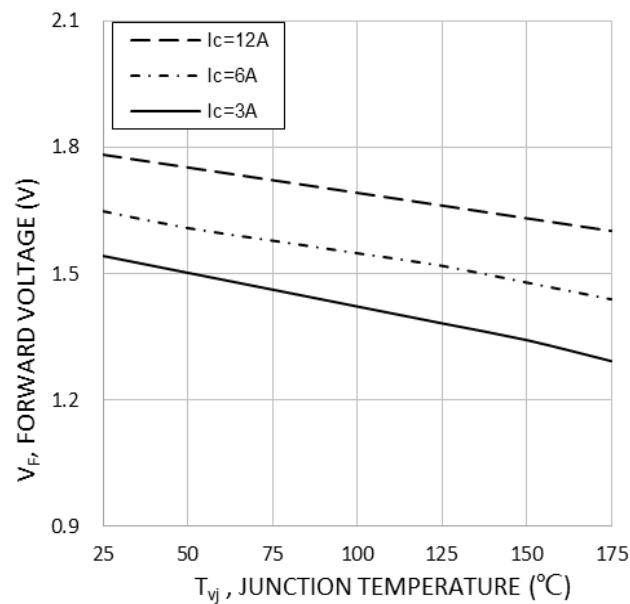


Fig. 14 Typical diode forward voltage as a function of junction temperature

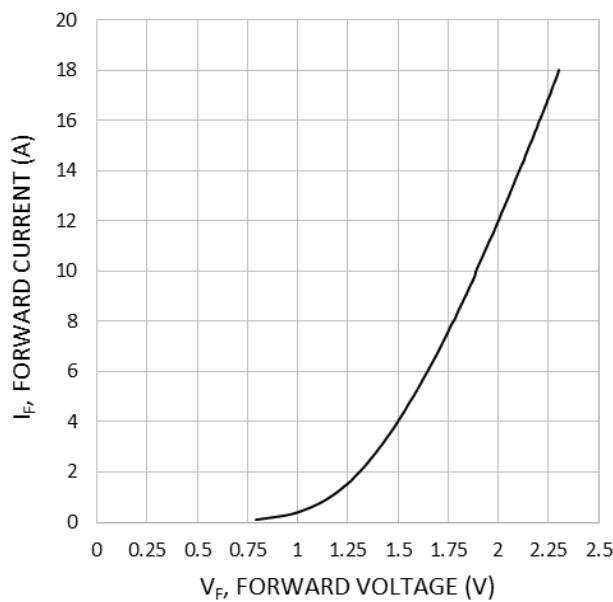


Fig. 15 Typical diode forward current as a function of forward voltage

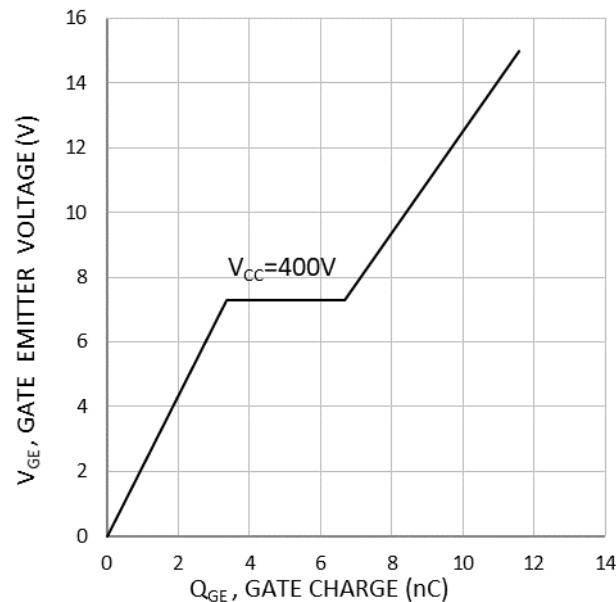


Fig. 16 Typical gate charge ($I_C=6A$)

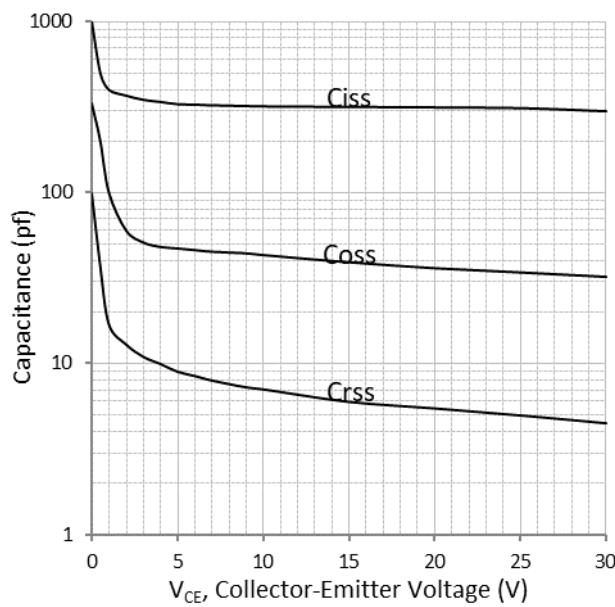


Fig. 17 Typical capacitance as a function of collector-emitter voltage ($V_{GE}=0V$, $f=1MHz$)

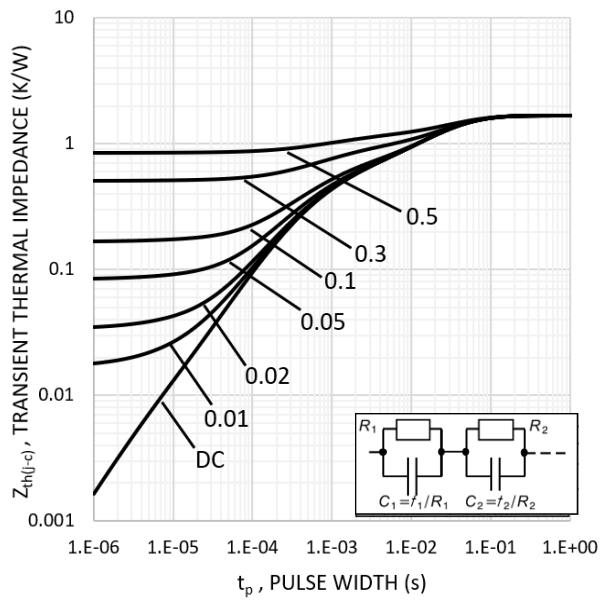


Fig. 18 IGBT transient thermal impedance ($D=t_p/T$) (TO-263)

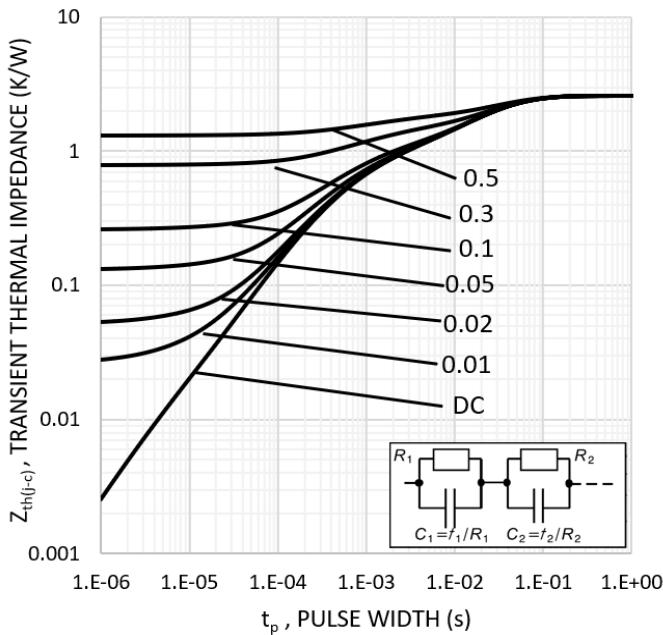
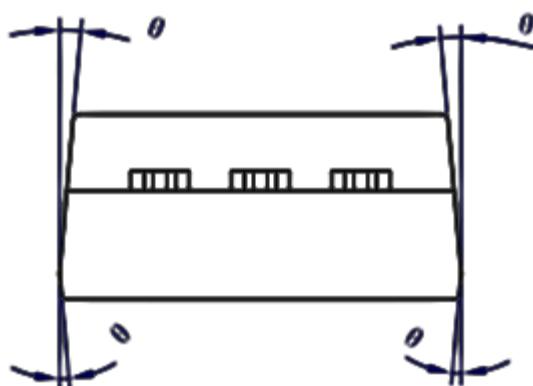
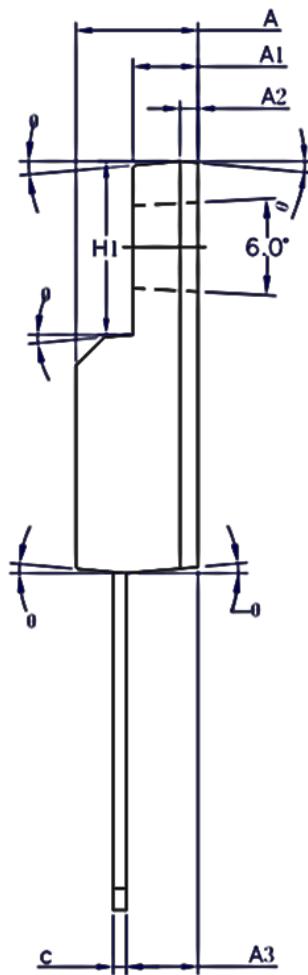
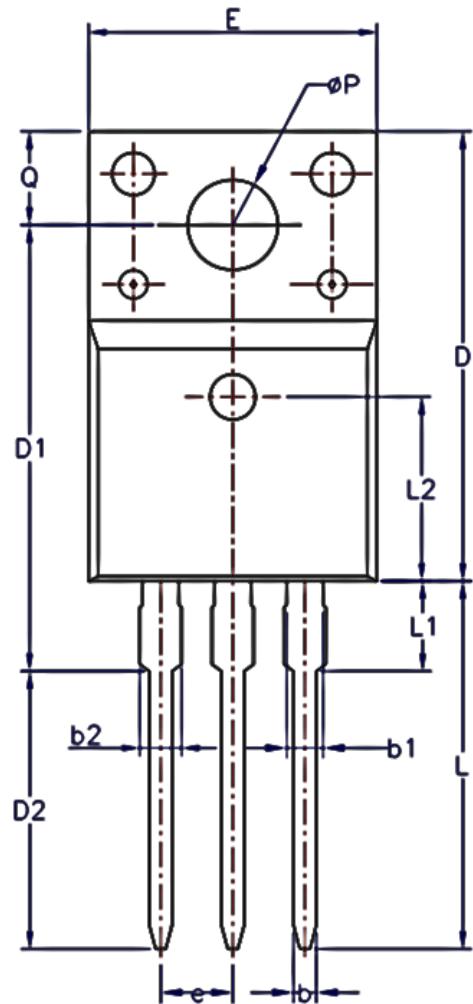


Fig. 19 FRD transient thermal impedance ($D=t_p/T$) (TO-263)

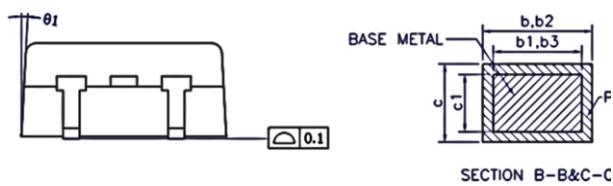
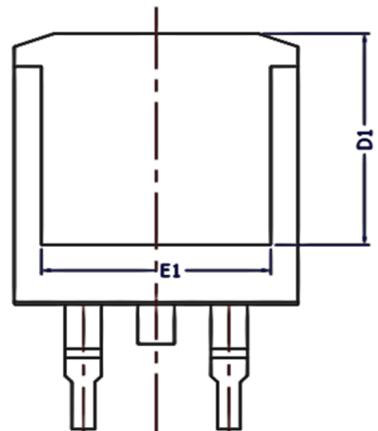
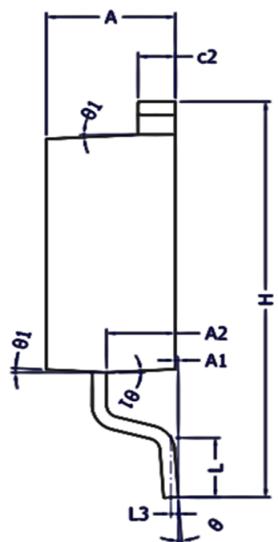
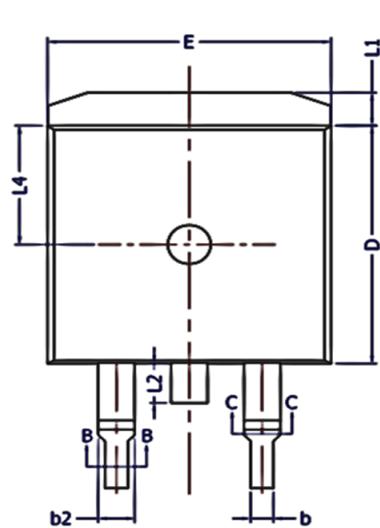
Package Information

TO-220F-3L



SYMBOL	MIN	NOM	MAX
A	4.50	4.70	4.83
A1	2.34	2.54	2.74
A2		0.70	REF
A3	2.56	2.76	2.93
b	0.70	—	0.90
b1	1.18	—	1.38
b2	—	—	1.47
c	0.45	0.50	0.60
D	15.67	15.87	16.07
D1	15.55	15.75	15.95
D2	9.60	9.80	10.0
E	9.96	10.16	10.36
e		2.54BSC	
H1	6.48	6.68	6.88
L	12.68	12.98	13.28
L1	—	—	3.50
L2		6.50REF	
ØP	3.08	3.18	3.28
Q	3.20	—	3.40
θ 1	1°	3°	5°

TO-263-2L

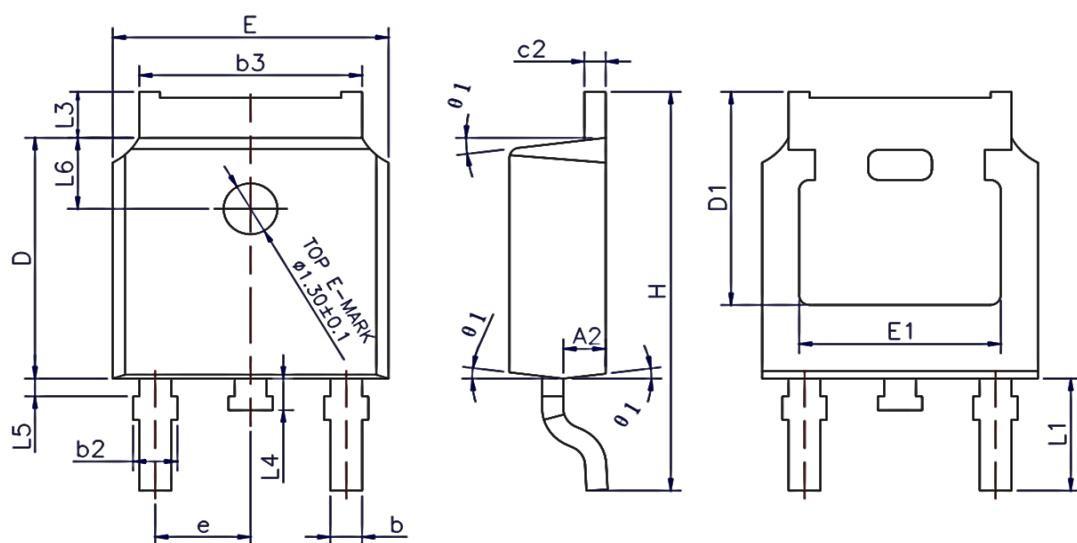


NOTES:
 ALL DIMENSIONS REFER TO JEDEC STANDARD TO-263 AB
 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

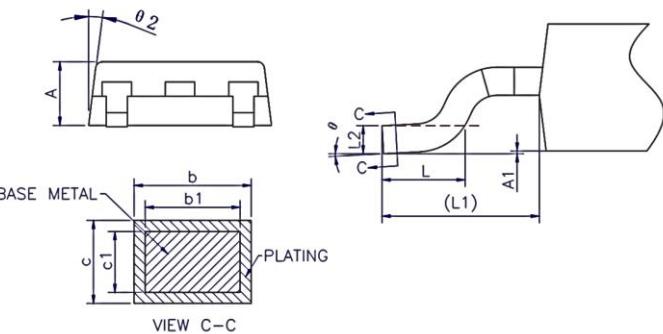
COMMON DIMENSIONS
 (UNITS OF MEASURE = MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	4.40	4.50	4.60
A1	0	0.10	0.25
A2	2.20	2.40	2.60
b	0.76	---	0.89
b1	0.75	0.80	0.85
b2	1.23	---	1.37
b3	1.22	1.27	1.32
c	0.47	---	0.60
c1	0.46	0.51	0.56
c2	1.25	1.30	1.35
D	9.10	9.20	9.30
D1	8.00	---	---
E	9.80	9.90	10.00
E1	7.80	---	---
e	2.54 BSC		
H	14.90	15.30	15.70
L	2.00	2.30	2.60
L1	1.17	1.27	1.40
L2	---	---	1.75
L3	0.25BSC		
L4	4.60 REF		
theta	0°	---	8°
theta1	1°	3°	5°

TO-252-2L


 COMMON DIMENSIONS
 (UNITS OF MEASURE = MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0	---	0.10
A2	0.90	1.01	1.10
b	0.72	---	0.85
b1	0.71	0.76	0.81
b2	0.72	---	0.90
b3	5.13	5.33	5.46
c	0.47	---	0.60
c1	0.46	0.51	0.56
c2	0.47	---	0.60
D	6.00	6.10	6.20
D1	5.25	---	---
E	6.50	6.60	6.70
E1	4.70	---	---
e	2.186	2.286	2.386
H	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90 REF		
L2	0.508 BSC		
L3	0.90	---	1.25
L4	0.60	0.80	1.00
L5	0.15	---	0.75
L6	1.80 REF		
θ	0°	---	8°
θ1	5°	7°	9°
θ2	5°	7°	9°



NOTES:
 ALL DIMENSIONS REFER TO JEDEC STANDARD
 TO-252 AA DO NOT INCLUDE MOLD FLASH OR
 PROTRUSIONS